



PATENT APPLICATION

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

#14/B  
4/23/3  
Sunk

In re application of

Docket No: Q67930

Hiroki TAKEUCHI, et al.

Appln. No.: 10/026,454

Group Art Unit: 2826

Confirmation No.: 1274

Examiner: Alexander O. Williams

Filed: December 27, 2001

April 17, 2003

For: EMBEDDING RESIN AND WIRING SUBSTRATE USING THE SAME

**AMENDMENT UNDER 37 C.F.R. § 1.111**

Commissioner for Patents  
Washington, D.C. 20231

Sir:

This is in response to the Office Action dated December 18, 2002. A Petition and payment for a one-month extension of time are attached, making this Amendment due on before April 18, 2003.

Please amend the above-identified application as follows:

**IN THE TITLE:**

Please delete the present title and replace it with the following new title:

WIRING SUBSTRATE USING EMBEDDING RESIN

**IN THE CLAIMS:**

Please cancel claims 8 and 11 without prejudice or disclaimer.

Please enter the following amended claims:

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